

Technical Data Sheet

TOP View LEDs

67-21/R6C-FS1U1B/2T

Features

- P-LCC-2 package.
- White package.
- Optical indicator.
- Colorless clear window.
- Wide viewing angle.
- Suitable for vapor-phase reflow, Infrared reflow and wave solder processes.
- Computable with automatic placement equipment.
- Available on tape and reel (8mm Tape).
- Pb-free.
- The product itself will remain within RoHS compliant version.



• The 67-21 series is available in soft orange, green, blue and yellow. Due to the package design, the LED has wide viewing angle and optimized light coupling by inter reflector. This feature makes the ideal for light pipe application. The low current requirement makes this device ideal for portable equipment or any other application where power is at a premium.

Applications

- Automotive: backlighting in dashboard and switch.
- Telecommunication: indicator and backlighting in telephone and fax.
- Flat backlight for LCD, switch and symbol.
- Light pipe application.
- General use.

Device Selection Guide

	Lana Calan		
Material	Emitted Color	Lens Color	
AlGaInP	Brilliant Red	Water Clear	

Everlight Electronics Co., Ltd.

Device No. :DSE-671-318

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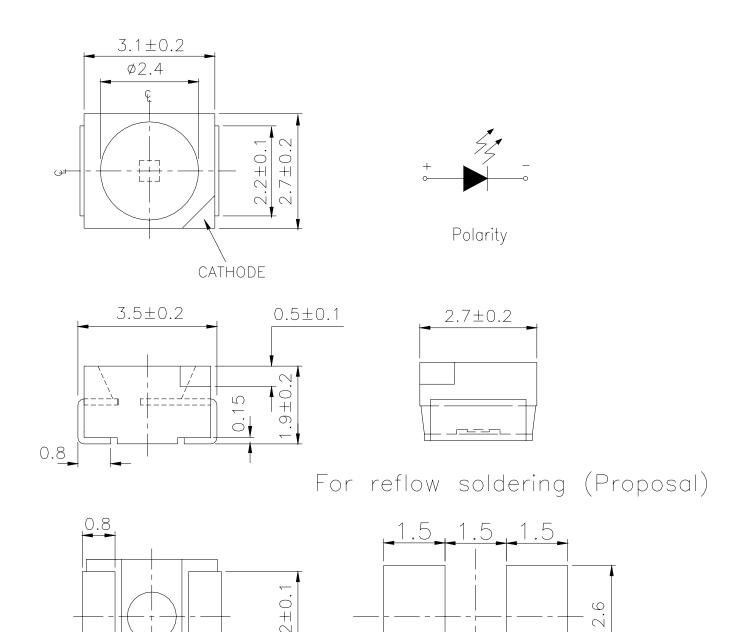
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Package Dimensions



Note: The tolerances unless mentioned is ± 0.1 mm Unit = mm

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Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Rating	Unit	
Reverse Voltage	V_R	5	V	
Forward Current	I F	50	mA	
Operating Temperature	Topr	-40 ~ +85	$^{\circ}\!\mathbb{C}$	
Storage Temperature	Tstg	-40 ~ +100	$^{\circ}\!\mathbb{C}$	
Electrostatic Discharge(HBM)	ESD	2000	V	
Power Dissipation	Pd	120	mW	
Peak Forward Current (Duty 1/10 @1KHz)	IFP	100	mA	
		Reflow Soldering: 260 °C for 10 sec		
Soldering Temperature	Tsol	Hand Soldering:	350 °C for 3 sec.	

Electro-Optical Characteristics (Ta=25°C)

	1						
Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition	
Luminous intensity	Iv	180		565	mcd	I _F =20mA	
Viewing Angle	2 \theta 1/2		120		deg	I _F =20mA	
Peak Wavelength	λр		632		nm	I _F =20mA	
Dominant Wavelength	λd	620.5		631	nm	I _F =20mA	
Spectrum Radiation Bandwidth	Δλ		20		nm	I _F =20mA	
Forward Voltage	VF	1.75	2.0	2.35	V	I _F =20mA	
Reverse Current	Ir			10	μΑ	VR=5V	

Notes:

1.Tolerance of Luminous Intensity ±10%

2.Tolerance of Dominant Wavelength ±1nm

3.Tolerance of Forward Voltage ±0.1V

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Bin Range Of Dominant Wavelength

Group	Bin Code	Min.	Max.	Unit	Condition
F	FF1	620.5	626.0	nm	I _F =20mA
	FF2	626.0	631.0	nm	IF=ZUIIIA

Bin Rang Of Luminous Intensity

Bin	Min	Max	Unit	Condition
S 1	180	225		
S2	225	285		
T1	285	360	mcd	I _F =20mA
T2	360	450		
U1	450	565		

Bin Rang Of Forward Voltage

Group	Bin	Min	Max	Unit	Condition	
	0	1.75	1.95			
D	1	1.95	2.15	V	I _F =20mA	
В	2	2.15	2.35			

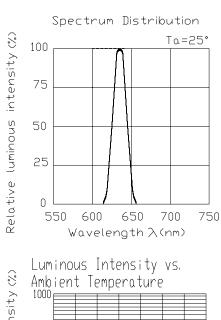
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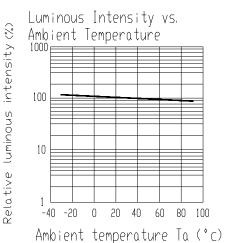
- 1.Tolerance of Luminous Intensity ±10%
- 2.Tolerance of Dominant Wavelength ±1nm
- 3.Tolerance of Forward Voltage ±0.1V

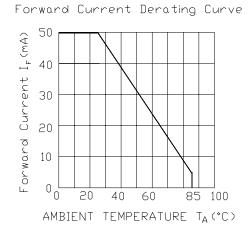
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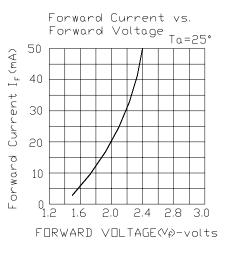
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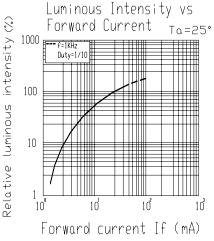
Typical Electro-Optical Characteristics Curves

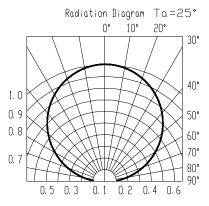














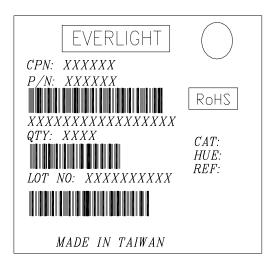
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Label explanation

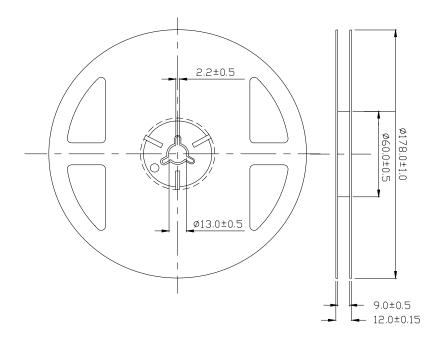
CAT: Luminous Intensity Rank

HUE: Dom. Wavelength Rank

REF: Forward Voltage Rank



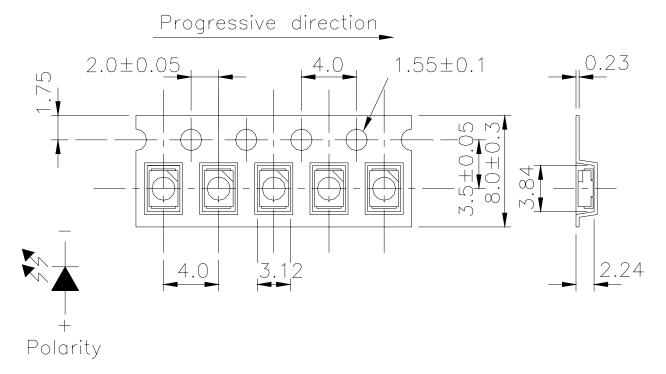
Reel Dimensions



Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm

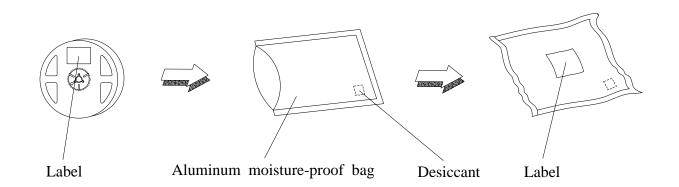
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Carrier Tape Dimensions: Loaded quantity 2000 PCS per reel.



Note: The tolerances unless mentioned is ± 0.1 mm Unit = mm

Moisture Resistant Packaging



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Reliability Test Items And Conditions

The reliability of products shall be satisfied with items listed below.

Confidence level: 90%

LTPD: 10%

No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
1	Reflow Soldering	Temp. : 260°C±5°C Min. 5sec.	6 min	22 PCS.	0/1
2	Temperature Cycle	$H: +100^{\circ}\mathbb{C}$ 15min \int 5 min $L: -40^{\circ}\mathbb{C}$ 15min	300 Cycles	22 PCS.	0/1
3	Thermal Shock	H:+100°C 5min ∫ 10 sec L:-10°C 5min	300 Cycles	22 PCS.	0/1
4	High Temperature Storage	Temp. : 100°C	1000 Hrs.	22 PCS.	0/1
5	Low Temperature Storage	Temp. : -40°C	1000 Hrs.	22 PCS.	0/1
6	DC Operating Life	$I_F = 20 \text{ mA}$	1000 Hrs.	22 PCS.	0/1
7	High Temperature / High Humidity	85°C / 85%RH	1000 Hrs.	22 PCS.	0/1



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Precautions For Use

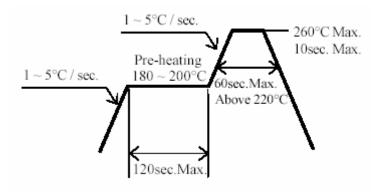
1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

2. Storage

- 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package: The LEDs should be kept at 30° C or less and 90%RH or less.
- 2.3 After opening the package: The LED's floor life is 1 year under 30 deg C or less and 60% RH or less. If unused LEDs remain, it should be stored in moisture proof packages.
- 2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

 Baking treatment: 60±5°C for 24 hours.
- 3. Soldering Condition
- 3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350° C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

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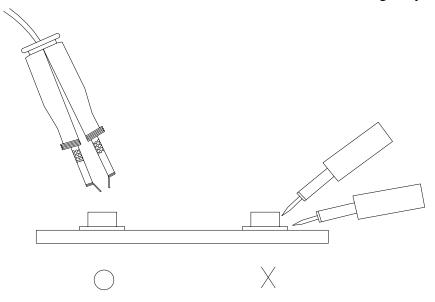
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5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



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